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## HEF4526B <br> Programmable 4-bit binary down counter

Rev. 5 - 22 November 2011
Product data sheet

## 1. General description

The HEF4526B is a synchronous programmable 4-bit binary down counter with active HIGH and active LOW clock inputs (CPO, $\overline{\mathrm{CP}} 1$ ), an asynchronous parallel load input (PL), four parallel inputs (A0 to A3), a cascade feedback input (CF), four buffered parallel outputs (Q0 to Q3), a terminal count output (TC), an overriding asynchronous master reset input (MR) and a decoded TC output that can be used for divide-by-n applications. In single stage applications the TC output is connected to PL. CF allows cascade divide-by-n operation with no additional gates required.

Information on A0 to A3 is loaded into the counter while PL is HIGH, independent of all other inputs except MR, which must be LOW. When PL and $\overline{\mathrm{CP}} 1$ are LOW, the counter advances on a LOW-to-HIGH transition of CPO. When PL is LOW and CPO is HIGH, the counter advances on a HIGH to LOW transition of $\overline{\mathrm{CP}} 1$. TC is HIGH when the counter is in the zero state $(\mathrm{Q} 0=\mathrm{Q} 1=\mathrm{Q} 2=\mathrm{Q} 3=\mathrm{LOW})$ and CF is HIGH and PL is LOW. A HIGH on MR resets the counter ( Q 0 to $\mathrm{Q} 3=\mathrm{LOW}$ ) independent of other inputs. The clock input is highly tolerant of slower clock rise and fall times due to Schmitt trigger action.

It operates over a recommended $\mathrm{V}_{\mathrm{DD}}$ power supply range of 3 V to 15 V referenced to $\mathrm{V}_{\mathrm{SS}}$ (usually ground). Unused inputs must be connected to $\mathrm{V}_{\mathrm{DD}}, \mathrm{V}_{\mathrm{SS}}$, or another input.

## 2. Features and benefits

- Fully static operation
- $5 \mathrm{~V}, 10 \mathrm{~V}$, and 15 V parametric ratings
- Standardized symmetrical output characteristics
- Specified from $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$
- Complies with JEDEC standard JESD 13-B


## 3. Ordering information

Table 1. Ordering information
All types operate from $-40^{\circ} \mathrm{C}$ to $+85^{\circ} \mathrm{C}$.

| Type number | Package |  |  |  |
| :--- | :--- | :--- | :--- | :--- |
|  | Name | Description | Version |  |
| HEF4526BP | DIP16 | plastic dual in-line package; 16 leads ( 300 mil) | SOT38-4 |  |
| HEF4526BT | SO16 | plastic small outline package; 16 leads; body width 3.9 mm | SOT109-1 |  |

## 4. Functional diagram



Fig 1. Functional diagram


Fig 2. Timing diagram


## 5. Pinning information

### 5.1 Pinning



Fig 4. Pin configuration

### 5.2 Pin description

Table 2. Pin description

| Symbol | Pin | Description |
| :--- | :--- | :--- |
| A0 to A3 | $5,11,14,2$ | parallel input |
| PL | 3 | parallel load input |
| CP0 | 6 | clock input (LOW-to-HIGH, triggered) |
| $\overline{C P} 1$ | 4 | clock input (HIGH-to-LOW, triggered) |
| CF | 13 | cascade feedback input |
| MR | 10 | asynchronous master reset input |
| TC | 12 | terminal count output |
| Q0 to Q3 | $7,9,15,1$ | buffered parallel output |
| $V_{D D}$ | 16 | supply voltage |
| $V_{S S}$ | 8 | ground $(0 \mathrm{~V})$ |

## 6. Functional description

Table 3. Function table[1]

| MR | PL | CPO | $\overline{\text { CP1 }}$ | Mode |
| :--- | :--- | :--- | :--- | :--- |
| H | X | X | X | reset (asynchronous) |
| L | H | X | X | preset (asynchronous) |
| L | L | $\uparrow$ | H | no change |
| L | L | L | $\downarrow$ | no change |
| L | L | X | X | no change |
| L | L | $\uparrow$ | $\uparrow$ | no change |
| L | L | H | L | counter advances |
| L | $\downarrow$ | counter advances |  |  |

[1] $H=$ HIGH voltage level; L = LOW voltage level; $X=$ don’t care; $\uparrow=$ positive-going transition; $\downarrow=$ negative-going transition.

Table 4. Counting mode
$C F=H I G H ; P L=L O W ; M R=L O W$.

| Count | Outputs |  |  |  |
| :---: | :---: | :---: | :---: | :---: |
|  | Q3 | Q2 | Q1 | Q0 |
| 15 | H | H | H | H |
| 14 | H | H | H | L |
| 13 | H | H | L | H |
| 12 | H | H | L | L |
| 11 | H | L | H | H |
| 10 | H | L | H | L |
| 9 | H | L | L | H |
| 8 | H | L | L | L |
| 7 | L | H | H | H |
| 6 | L | H | H | L |
| 5 | L | H | L | H |
| 4 | L | H | L | L |
| 3 | L | L | H | H |
| 2 | L | L | H | L |
| 1 | L | L | L | H |
| 0 | L | L | L | L |

Table 5. Single stage operation
Divide-by-n; MR = LOW; CF = HIGH; $\overline{C P} 1=L O W$.

| PL | A3 | A2 | A1 | A0 | Divide by | TC output pulse width |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| L | X | X | X | X | 16 | one clock period |
| TC | H | H | H | H | 15 | clock pulse HIGH |
| TC | H | H | H | L | 14 |  |
| TC | H | H | L | H | 13 |  |
| TC | H | H | L | L | 12 |  |
| TC | H | L | H | H | 11 |  |
| TC | H | L | H | L | 10 |  |
| TC | H | L | L | H | 9 |  |
| TC | H | L | L | L | 8 |  |
| TC | L | H | H | H | 7 |  |
| TC | L | H | H | L | 6 |  |
| TC | L | H | L | H | 5 |  |
| TC | L | H | L | L | 4 |  |
| TC | L | L | H | H | 3 |  |
| TC | L | L | H | L | 2 |  |
| TC | L | L | L | H | 1 |  |
| TC | L | L | L | L | no operatio |  |



Fig 5. State diagram

## 7. Limiting values

Table 6. Limiting values
In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol | Parameter | Conditions | Min | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: |
| $V_{D D}$ | supply voltage |  | -0.5 | +18 | V |
| $\mathrm{I}_{\mathrm{IK}}$ | input clamping current | $\mathrm{V}_{1}<-0.5 \mathrm{~V}$ or $\mathrm{V}_{1}>\mathrm{V}_{\mathrm{DD}}+0.5 \mathrm{~V}$ | - | $\pm 10$ | mA |
| V | input voltage |  | -0.5 | $V_{D D}+0.5$ | V |
| $\mathrm{l}_{\mathrm{OK}}$ | output clamping current | $\mathrm{V}_{\mathrm{O}}<-0.5 \mathrm{~V}$ or $\mathrm{V}_{\mathrm{O}}>\mathrm{V}_{\mathrm{DD}}+0.5 \mathrm{~V}$ | - | $\pm 10$ | mA |
| $l_{\text {I/O }}$ | input/output current |  | - | $\pm 10$ | mA |
| $\mathrm{I}_{\mathrm{DD}}$ | supply current | to any supply terminal | - | $\pm 100$ | mA |
| $\mathrm{T}_{\text {stg }}$ | storage temperature |  | -65 | +150 | ${ }^{\circ} \mathrm{C}$ |
| Tamb | ambient temperature |  | -40 | +85 | ${ }^{\circ} \mathrm{C}$ |
| $P_{\text {tot }}$ | total power dissipation | DIP16 package | [1] | 750 | mW |
|  |  | SO16 package | [2] - | 500 | mW |
| P | power dissipation | per output | - | 100 | mW |

[1] For DIP16 package: $P_{\text {tot }}$ derates linearly with $12 \mathrm{~mW} / \mathrm{K}$ above $70^{\circ} \mathrm{C}$.
[2] For SO16 package: $\mathrm{P}_{\text {tot }}$ derates linearly with $8 \mathrm{~mW} / \mathrm{K}$ above $70^{\circ} \mathrm{C}$.

## 8. Recommended operating conditions

Table 7. Recommended operating conditions

| Symbol | Parameter | Conditions | Min | Typ | Max | Unit |
| :--- | :--- | :--- | :--- | :--- | :--- | :--- |
| $\mathrm{V}_{\mathrm{DD}}$ | supply voltage |  | 3 | - | 15 | V |
| $\mathrm{~V}_{\mathrm{I}}$ | input voltage |  | 0 | - | $\mathrm{V}_{\mathrm{DD}}$ | V |
| $\mathrm{T}_{\mathrm{amb}}$ | ambient temperature | in free air | -40 | - | +85 | ${ }^{\circ} \mathrm{C}$ |
| $\Delta \mathrm{t} / \Delta \mathrm{V}$ | input transition rise and fall rate | $\mathrm{V}_{\mathrm{CC}}=5 \mathrm{~V}$ | - | - | 3.75 | $\mu \mathrm{~s} / \mathrm{V}$ |
|  |  | $\mathrm{V}_{\mathrm{CC}}=10 \mathrm{~V}$ | - | - | 0.5 | $\mu \mathrm{~s} / \mathrm{V}$ |
|  |  | $\mathrm{V}_{\mathrm{CC}}=15 \mathrm{~V}$ | - | - | 0.08 | $\mu \mathrm{~s} / \mathrm{V}$ |

## 9. Static characteristics

Table 8. Static characteristics
$V_{S S}=0 V ; V_{I}=V_{S S}$ or $V_{D D}$ unless otherwise specified.

| Symbol | Parameter | Conditions | $V_{\text {DD }}$ | $\mathrm{T}_{\mathrm{amb}}=-40^{\circ} \mathrm{C}$ |  | $\mathrm{T}_{\mathrm{amb}}=25^{\circ} \mathrm{C}$ |  | $\mathrm{T}_{\text {amb }}=85^{\circ} \mathrm{C}$ |  | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  |  |  |  | Min | Max | Min | Max | Min | Max |  |
| $\mathrm{V}_{\mathrm{IH}}$ | HIGH-level input voltage | $\left\|\mathrm{l}_{\mathrm{O}}\right\|<1 \mu \mathrm{~A}$ | 5 V | 3.5 | - | 3.5 | - | 3.5 | - | V |
|  |  |  | 10 V | 7.0 | - | 7.0 | - | 7.0 | - | V |
|  |  |  | 15 V | 11.0 | - | 11.0 | - | 11.0 | - | V |
| $\mathrm{V}_{\text {IL }}$ | LOW-level input voltage | $\left\|\mathrm{l}_{\mathrm{O}}\right\|<1 \mu \mathrm{~A}$ | 5 V | - | 1.5 | - | 1.5 | - | 1.5 | V |
|  |  |  | 10 V | - | 3.0 | - | 3.0 | - | 3.0 | V |
|  |  |  | 15 V | - | 4.0 | - | 4.0 | - | 4.0 | V |
| $\mathrm{V}_{\mathrm{OH}}$ | HIGH-level output voltage | $\|\mathrm{lo}\|<1 \mu \mathrm{~A}$ | 5 V | 4.95 | - | 4.95 | - | 4.95 | - | V |
|  |  |  | 10 V | 9.95 | - | 9.95 | - | 9.95 | - | V |
|  |  |  | 15 V | 14.95 | - | 14.95 | - | 14.95 | - | V |
| $\mathrm{V}_{\text {OL }}$ | LOW-level output voltage | $\mid \mathrm{l}_{\mathrm{O}} \mathrm{l}<1 \mu \mathrm{~A}$ | 5 V | - | 0.05 | - | 0.05 | - | 0.05 | V |
|  |  |  | 10 V | - | 0.05 | - | 0.05 | - | 0.05 | V |
|  |  |  | 15 V | - | 0.05 | - | 0.05 | - | 0.05 | V |
| loL | LOW-level output current | $\mathrm{V}_{\mathrm{O}}=0.4 \mathrm{~V}$ | 5 V | 0.52 | - | 0.44 | - | 0.36 | - | mA |
|  |  | $\mathrm{V}_{\mathrm{O}}=0.5 \mathrm{~V}$ | 10 V | 1.3 | - | 1.1 | - | 0.9 | - | mA |
|  |  | $\mathrm{V}_{\mathrm{O}}=1.5 \mathrm{~V}$ | 15 V | 3.6 | - | 3.0 | - | 2.4 | - | $m A$ |
| IOH | HIGH-level output current | $\mathrm{V}_{\mathrm{O}}=2.5 \mathrm{~V}$ | 5 V | - | -1.7 | - | -1.4 | - | -1.1 | mA |
|  |  | $\mathrm{V}_{\mathrm{O}}=4.6 \mathrm{~V}$ | 5 V | - | -0.52 | - | -0.44 | - | -0.36 | mA |
|  |  | $\mathrm{V}_{\mathrm{O}}=9.5 \mathrm{~V}$ | 10 V | - | -1.3 | - | -1.1 | - | -0.9 | mA |
|  |  | $\mathrm{V}_{\mathrm{O}}=13.5 \mathrm{~V}$ | 15 V | - | -3.6 | - | -3.0 | - | -2.4 | $m A$ |
| 1 | input leakage current |  | 15 V | - | $\pm 0.3$ | - | $\pm 0.3$ | - | $\pm 1.0$ | $\mu \mathrm{A}$ |
| $I_{\text {DD }}$ | supply current | $\mathrm{I}_{0}=0 \mathrm{~A}$ | 5 V | - | 20 | - | 20 | - | 150 | $\mu \mathrm{A}$ |
|  |  |  | 10 V | - | 40 | - | 40 | - | 300 | $\mu \mathrm{A}$ |
|  |  |  | 15 V | - | 80 | - | 80 | - | 600 | $\mu \mathrm{A}$ |
| CI | input capacitance |  | - | - | - | - | 7.5 | - | - | pF |

## 10. Dynamic characteristics

Table 9. Dynamic characteristics
$V_{S S}=0 \mathrm{~V}$; $T_{a m b}=25^{\circ} \mathrm{C}$; for test circuit see Figure 7; unless otherwise specified.

| Symbol | Parameter | Conditions | $\mathrm{V}_{\mathrm{DD}}$ |  | Extrapolation formula | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| $t_{\text {PHL }}$ | HIGH to LOW propagation delay | $\mathrm{CP} 0, \overline{\mathrm{CP}} 1$ to Qn ; see Figure 6 | 5 V | [1] | $123 \mathrm{~ns}+(0.55 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 150 | 300 | ns |
|  |  |  | 10 V |  | $54 \mathrm{~ns}+(0.23 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 65 | 130 | ns |
|  |  |  | 15 V |  | $42 \mathrm{~ns}+(0.16 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 50 | 100 | ns |
|  |  | $\begin{aligned} & \mathrm{CP} 0, \overline{\mathrm{CP}} 1 \text { to } \mathrm{TC} \text {; } \\ & \text { see Figure } 6 \end{aligned}$ | 5 V |  | $183 \mathrm{~ns}+(0.55 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 210 | 420 | ns |
|  |  |  | 10 V |  | $79 \mathrm{~ns}+(0.23 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 90 | 180 | ns |
|  |  |  | 15 V |  | $62 \mathrm{~ns}+(0.16 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 70 | 140 | ns |
|  |  | PL to Qn; see Figure 6 | 5 V |  | $173 \mathrm{~ns}+(0.55 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 200 | 400 | ns |
|  |  |  | 10 V |  | $69 \mathrm{~ns}+(0.23 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 80 | 160 | ns |
|  |  |  | 15 V |  | $52 \mathrm{~ns}+(0.16 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 60 | 120 | ns |
|  |  | MR to Qn | 5 V |  | $113 \mathrm{~ns}+(0.55 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 140 | 280 | ns |
|  |  |  | 10 V |  | $44 \mathrm{~ns}+(0.23 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 55 | 110 | ns |
|  |  |  | 15 V |  | $32 \mathrm{~ns}+(0.16 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 40 | 80 | ns |
| $t_{\text {PLH }}$ | LOW to HIGH propagation delay | $\mathrm{CP} 0, \overline{\mathrm{CP}} 1$ to Qn ; see Figure 6 | 5 V | [1] | $123 \mathrm{~ns}+(0.55 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 150 | 300 | ns |
|  |  |  | 10 V |  | $54 \mathrm{~ns}+(0.23 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 65 | 130 | ns |
|  |  |  | 15 V |  | $42 \mathrm{~ns}+(0.16 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 50 | 100 | ns |
|  |  | CP0, $\overline{\mathrm{CP}} 1$ to TC; see Figure 6 | 5 V |  | $183 \mathrm{~ns}+(0.55 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 210 | 420 | ns |
|  |  |  | 10 V |  | $79 \mathrm{~ns}+(0.23 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 90 | 180 | ns |
|  |  |  | 15 V |  | $62 \mathrm{~ns}+(0.16 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 70 | 140 | ns |
|  |  | PL to Qn; see Figure 6 | 5 V |  | $153 \mathrm{~ns}+(0.55 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 180 | 360 | ns |
|  |  |  | 10 V |  | $59 \mathrm{~ns}+(0.23 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 70 | 140 | ns |
|  |  |  | 15 V |  | $42 \mathrm{~ns}+(0.16 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 50 | 100 | ns |
| $t_{t}$ | transition time | see Figure 6 | 5 V | [1] | $10 \mathrm{~ns}+(1.00 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 60 | 120 | ns |
|  |  |  | 10 V |  | $9 \mathrm{~ns}+(0.42 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 30 | 60 | ns |
|  |  |  | 15 V |  | $6 \mathrm{~ns}+(0.28 \mathrm{~ns} / \mathrm{pF}) \mathrm{C}_{\mathrm{L}}$ | - | 20 | 40 | ns |
| $\mathrm{t}_{\text {su }}$ | set-up time | An to PL; see Figure 6 | 5 V |  |  | 30 | 0 | - | ns |
|  |  |  | 10 V |  |  | 20 | 0 | - | ns |
|  |  |  | 15 V |  |  | 15 | 0 | - | ns |
| $t_{n}$ | hold time | An to PL; see Figure 6 | 5 V |  |  | 30 | 5 | - | ns |
|  |  |  | 10 V |  |  | 20 | 5 | - | ns |
|  |  |  | 15 V |  |  | 15 | 5 | - | ns |

Table 9. Dynamic characteristics ...continued
$V_{S S}=0 V ; T_{\text {amb }}=25^{\circ} \mathrm{C}$; for test circuit see Figure 7; unless otherwise specified.

| Symbol | Parameter | Conditions | $V_{\text {DD }}$ | Extrapolation formula | Min | Typ | Max | Unit |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| tw | pulse width | CPO input; LOW; see Figure 6 | 5 V |  | 80 | 40 | - | ns |
|  |  |  | 10 V |  | 40 | 20 | - | ns |
|  |  |  | 15 V |  | 30 | 15 | - | ns |
|  |  | $\overline{\mathrm{CP}} 1$ input; HIGH; see Figure 6 | 5 V |  | 80 | 40 | - | ns |
|  |  |  | 10 V |  | 40 | 20 | - | ns |
|  |  |  | 15 V |  | 30 | 15 | - | ns |
|  |  | PL input; HIGH; see Figure 6 | 5 V |  | 100 | 50 | - | ns |
|  |  |  | 10 V |  | 40 | 20 | - | ns |
|  |  |  | 15 V |  | 32 | 16 | - | ns |
|  |  | MR input; LOW | 5 V |  | 130 | 65 | - | ns |
|  |  |  | 10 V |  | 50 | 25 | - | ns |
|  |  |  | 15 V |  | 40 | 20 | - | ns |
| $\mathrm{f}_{\text {max }}$ | maximum frequency | $\begin{aligned} & \text { PL = LOW; } \\ & \text { see Figure } 6 \end{aligned}$ | 5 V |  | 6 | 12 | - | MHz |
|  |  |  | 10 V |  | 12 | 25 | - | MHz |
|  |  |  | 15 V |  | 16 | 32 | - | MHz |

[1] The typical values of the propagation delay and transition times are calculated from the extrapolation formulas shown ( $\mathrm{C}_{\mathrm{L}}$ in pF ).
[2] In the divide-by-n mode (PL connected to TC), the CPO or $\overline{\mathrm{CP}} 1$ pulse width must be greater than the maximum HIGH to LOW propagation delay for CP0 or $\overline{\mathrm{CP}} 1$ to TC .

Table 10. Dynamic power dissipation $\mathrm{P}_{\mathrm{D}}$
$P_{D}$ can be calculated from the formulas shown. $V_{S S}=0 \mathrm{~V} ; t_{r}=t_{f} \leq 20 \mathrm{~ns} ; T_{\text {amb }}=25^{\circ} \mathrm{C}$.

| Symbol | Parameter | $\mathrm{V}_{\mathrm{DD}}$ | Typical formula for $\mathrm{P}_{\mathrm{D}}(\mu \mathrm{W})$ | where: |
| :---: | :---: | :---: | :---: | :---: |
| $\mathrm{P}_{\mathrm{D}}$ | dynamic power dissipation | 5 V | $\mathrm{P}_{\mathrm{D}}=1000 \times \mathrm{f}_{\mathrm{i}}+\Sigma\left(\mathrm{f}_{\mathrm{o}} \times \mathrm{C}_{\mathrm{L}}\right) \times \mathrm{V}_{\text {DD }}{ }^{2}$ | $\mathrm{f}_{\mathrm{i}}=$ input frequency in MHz , |
|  |  | 10 V | $\mathrm{P}_{\mathrm{D}}=4000 \times \mathrm{f}_{\mathrm{i}}+\Sigma\left(\mathrm{f}_{\mathrm{O}} \times \mathrm{C}_{\mathrm{L}}\right) \times \mathrm{V}_{\text {DD }}{ }^{2}$ | $\mathrm{f}_{0}=$ output frequency in MHz , |
|  |  | 15 V | $\mathrm{P}_{\mathrm{D}}=10000 \times \mathrm{f}_{\mathrm{i}}+\Sigma\left(\mathrm{f}_{0} \times \mathrm{C}_{L}\right) \times \mathrm{V}_{\text {D }}{ }^{2}$ | $\mathrm{C}_{\mathrm{L}}=$ output load capacitance in pF , <br> $\mathrm{V}_{\mathrm{DD}}=$ supply voltage in V , <br> $\Sigma\left(\mathrm{f}_{\mathrm{o}} \times \mathrm{C}_{\mathrm{L}}\right)=$ sum of the outputs. |

11. Waveforms

a. Propagation delays for $\mathrm{CP} 0, \overline{\mathrm{CP}} 1$ to Qn , and TC , minimum CP 0 and $\overline{\mathrm{CP}} 1$ pulse widths and maximum frequency

b. Propagation delays for PL and An to Qn , setup and hold times for PL to An, Qn transition times and minimum PL pulse width
Measurement points are given in Table 11.
The logic levels $\mathrm{V}_{\mathrm{OH}}$ and $\mathrm{V}_{\mathrm{OL}}$ are typical output voltage levels that occur with the output load.
Fig 6. Waveforms showing switching times

a. Input waveforms

b. Test circuit

Test data is given in Table 11;
Definitions for test circuit:
DUT = Device Under Test;
$C_{L}=$ Load capacitance, including jig and probe capacitance;
$R_{L}=$ Load resistance;
$\mathrm{R}_{\mathrm{T}}=$ Termination resistance, should be equal to the output impedance $\mathrm{Z}_{0}$ of the pulse generator.
Fig 7. Test circuit for switching times

Table 11. Measurement points and test data

| Supply voltage | Input |  |  | Load |  |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | $V_{1}$ | $\mathrm{V}_{\mathrm{M}}$ | $\mathrm{t}_{\mathrm{r}}, \mathrm{t}_{\mathrm{f}}$ | $\mathrm{C}_{\mathrm{L}}$ | $\mathbf{R}_{\mathrm{L}}$ |
| 5 V to 15 V | $V_{D D}$ | 0.5 V I | $\leq 20 \mathrm{~ns}$ | 50 pF | $1 \mathrm{k} \Omega$ |

## 12. Application information

Some examples of HEF4526B applications are:

- Divide-by-n counter
- Programmable frequency divider

L.S.D. $=$ Least Significant Digit; M.S.D. $=$ Most Significant Digit.

Fig 8. Typical 2-stage programmable down counter (one cycle) application.

L.S.D. = Least Significant Digit; M.S.D. $=$ Most Significant Digit.

Fig 9. Typical 2-stage programmable frequency divider application

## 13. Package outline



DIMENSIONS (inch dimensions are derived from the original mm dimensions)

| UNIT | A max. | $\mathbf{A}_{1}$ min. | $\underset{\max .}{\mathbf{A}_{2}}$ | b | $\mathrm{b}_{1}$ | $\mathrm{b}_{2}$ | C | $D^{(1)}$ | $E^{(1)}$ | e | $\mathbf{e}_{1}$ | L | $\mathrm{M}_{\mathrm{E}}$ | $\mathbf{M}_{\mathbf{H}}$ | w | $\begin{gathered} Z^{(1)} \\ \max . \end{gathered}$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| mm | 4.2 | 0.51 | 3.2 | $\begin{aligned} & 1.73 \\ & 1.30 \end{aligned}$ | $\begin{aligned} & 0.53 \\ & 0.38 \end{aligned}$ | $\begin{aligned} & 1.25 \\ & 0.85 \end{aligned}$ | $\begin{aligned} & 0.36 \\ & 0.23 \end{aligned}$ | $\begin{aligned} & 19.50 \\ & 18.55 \end{aligned}$ | $\begin{aligned} & 6.48 \\ & 6.20 \end{aligned}$ | 2.54 | 7.62 | $\begin{aligned} & 3.60 \\ & 3.05 \end{aligned}$ | $\begin{aligned} & 8.25 \\ & 7.80 \end{aligned}$ | $\begin{gathered} 10.0 \\ 8.3 \end{gathered}$ | 0.254 | 0.76 |
| inches | 0.17 | 0.02 | 0.13 | $\begin{aligned} & 0.068 \\ & 0.051 \end{aligned}$ | $\begin{aligned} & 0.021 \\ & 0.015 \end{aligned}$ | $\begin{aligned} & 0.049 \\ & 0.033 \end{aligned}$ | $\begin{aligned} & 0.014 \\ & 0.009 \end{aligned}$ | $\begin{aligned} & 0.77 \\ & 0.73 \end{aligned}$ | $\begin{aligned} & 0.26 \\ & 0.24 \end{aligned}$ | 0.1 | 0.3 | $\begin{aligned} & 0.14 \\ & 0.12 \end{aligned}$ | $\begin{aligned} & 0.32 \\ & 0.31 \end{aligned}$ | $\begin{aligned} & 0.39 \\ & 0.33 \end{aligned}$ | 0.01 | 0.03 |

Note

1. Plastic or metal protrusions of 0.25 mm ( 0.01 inch ) maximum per side are not included.

| OUTLINE VERSION | REFERENCES |  |  | EUROPEAN PROJECTION | ISSUE DATE |
| :---: | :---: | :---: | :---: | :---: | :---: |
|  | IEC | JEDEC | JEITA |  |  |
| SOT38-4 |  |  |  | $\square$ (+) | $\begin{aligned} & -95-01-14 \\ & 03-02-13 \end{aligned}$ |

Fig 10. Package outline SOT38-4 (DIP16)


DIMENSIONS (inch dimensions are derived from the original mm dimensions)

| UNIT | $\begin{gathered} \mathrm{A} \\ \max . \end{gathered}$ | $\mathrm{A}_{1}$ | $\mathrm{A}_{2}$ | $\mathrm{A}_{3}$ | $\mathrm{b}_{\mathrm{p}}$ | c | $D^{(1)}$ | $E^{(1)}$ | e | $\mathrm{H}_{\mathrm{E}}$ | L | $\mathrm{L}_{\mathrm{p}}$ | Q | v | w | y | $Z^{(1)}$ | $\theta$ |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: | :---: |
| mm | 1.75 | $\begin{aligned} & 0.25 \\ & 0.10 \end{aligned}$ | $\begin{aligned} & 1.45 \\ & 1.25 \end{aligned}$ | 0.25 | $\begin{aligned} & 0.49 \\ & 0.36 \end{aligned}$ | $\begin{aligned} & 0.25 \\ & 0.19 \end{aligned}$ | $\begin{gathered} 10.0 \\ 9.8 \end{gathered}$ | $\begin{aligned} & 4.0 \\ & 3.8 \end{aligned}$ | 1.27 | $\begin{aligned} & 6.2 \\ & 5.8 \end{aligned}$ | 1.05 | $\begin{aligned} & 1.0 \\ & 0.4 \end{aligned}$ | $\begin{aligned} & 0.7 \\ & 0.6 \end{aligned}$ | 0.25 | 0.25 | 0.1 | $\begin{aligned} & 0.7 \\ & 0.3 \end{aligned}$ | $8^{\circ}$ |
| inches | 0.069 | $\begin{aligned} & 0.010 \\ & 0.004 \end{aligned}$ | $\begin{aligned} & 0.057 \\ & 0.049 \end{aligned}$ | 0.01 | $\begin{aligned} & 0.019 \\ & 0.014 \end{aligned}$ | $\begin{array}{l\|} \hline 0.0100 \\ 0.0075 \end{array}$ | $\begin{aligned} & 0.39 \\ & 0.38 \end{aligned}$ | $\begin{aligned} & 0.16 \\ & 0.15 \end{aligned}$ | 0.05 | $\begin{aligned} & 0.244 \\ & 0.228 \end{aligned}$ | 0.041 | $\begin{array}{\|l\|} \hline 0.039 \\ 0.016 \end{array}$ | $\begin{aligned} & 0.028 \\ & 0.020 \end{aligned}$ | 0.01 | 0.01 | 0.004 | $\begin{aligned} & \hline 0.028 \\ & 0.012 \end{aligned}$ | $0^{\circ}$ |

Note

1. Plastic or metal protrusions of 0.15 mm ( 0.006 inch ) maximum per side are not included.

| OUTLINE <br> VERSION | REFERENCES |  |  |  | EUROPEAN <br> PROJECTION | ISSUE DATE |
| :---: | :---: | :---: | :---: | :---: | :---: | :---: |
|  | IEC | JEDEC | JEITA |  |  |  |

Fig 11. Package outline SOT109-1 (SO16)

## 14. Revision history

Table 12. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
| :---: | :---: | :---: | :---: | :---: |
| HEF4526B v. 5 | 20111122 | Product data sheet | - | HEF4526B v. 4 |
| Modifications: | - Section Applications removed <br> - Table 8: $\mathrm{I}_{\mathrm{OH}}$ minimum values changed to maximum |  |  |  |
| HEF4526B v. 4 | 20090921 | Product data sheet | - | HEF4526B_CNV v. 3 |
| HEF4526B_CNV v. 3 | 19950101 | Product specification | - | HEF4526B_CNV v. 2 |
| HEF4526B_CNV v. 2 | 19950101 | Product specification | - | - |

## 15. Legal information

### 15.1 Data sheet status

| Document status $[1][2]$ | Product status $[3]$ | Definition |
| :--- | :--- | :--- |
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

[1] Please consult the most recently issued document before initiating or completing a design.
[2] The term 'short data sheet' is explained in section "Definitions".
[3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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